

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Yasutaka Toyoda</td><td>07/09/2007</td></tr><tr><td>Takumichi Sutani</td><td>07/11/2007</td></tr><tr><td>Ryoichi Matsuoka</td><td>07/11/2007</td></tr><tr><td>Hidemitsu Naya</td><td>07/17/2007</td></tr></tbody></table>	Name	Execution Date	Yasutaka Toyoda	07/09/2007	Takumichi Sutani	07/11/2007	Ryoichi Matsuoka	07/11/2007	Hidemitsu Naya	07/17/2007	
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RECEIVING PARTY DATA											
Name:	Hitachi High-Technologies Corporation										
Street Address:	1-24-14, Nishi Shinbashi										
City:	Minato-ku, Tokyo										
State/Country:	JAPAN										
PROPERTY NUMBERS Total: 1											
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11834218</td></tr></tbody></table>	Property Type	Number	Application Number:	11834218							
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Application Number:	11834218										
CORRESPONDENCE DATA											
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Total Attachments: 1 source=ASSIGN#page1.tif											

OP \$40.00 11834218

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PATENT
REEL: 022656 FRAME: 0911

ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Technologies Corporation, a corporation organized under the laws of Japan, located at 1-24-14, Nishi Shinbashi, Minato-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Technologies Corporation, its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

PATTERN INSPECTION APPARATUS AND SEMICONDUCTOR INSPECTION SYSTEM

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi High-Technologies Corporation, its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Technologies Corporation,

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1)	<u>Yasutaka Toyoda</u> ^{Y.T 7/9/2007}	<u>7 / 9 / 2007</u>
2)	<u>T. Saito</u>	<u>7 / 11 / 2007</u>
3)	<u>Reyoichi Matsuoka</u>	<u>7 / 11 / 2007</u>
4)	<u>Hidemitsu Kaya</u>	<u>7 / 17 / 2007</u>
5)	_____	_____
6)	_____	_____
7)	_____	_____
8)	_____	_____
9)	_____	_____
10)	_____	_____

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RECORDED: 05/08/2009

REEL: 022656 FRAME: 0912